

TRANSMITTAL

Electronic Version v1.1

Stylesheet Version v1.1.0

| Title of Invention | METHOD FOR OPTIMAL USE OF DIRECT FIT AND INTERPOLATED MODELS IN SCHEMATIC CUSTOM DESIGN OF ELECTRICAL CIRCUITS | | | | | | | |
|--|---|----------------|---------------|-------------|----------------|--|---------------------------|----------|
| <p>Application Number :</p> <p>Date :</p> <p>First Named Applicant: Joseph A. Iadanza</p> <p>Confirmation Number:</p> <p>Attorney Docket Number: BUR920030174US1</p> | | | | | | | | |
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| <table border="1"><thead><tr><th data-bbox="85 632 495 658">Submitted By:</th><th data-bbox="495 632 709 658">Elec. Sign.</th><th data-bbox="709 632 902 658">Sign. Capacity</th></tr></thead><tbody><tr><td data-bbox="85 658 495 704">Richard A. Henkler Esq. Registered Number: 39,220</td><td data-bbox="495 658 709 704">Richard A. Henkler /s/</td><td data-bbox="709 658 902 704">Attorney</td></tr></tbody></table> | | | Submitted By: | Elec. Sign. | Sign. Capacity | Richard A. Henkler Esq. Registered Number: 39,220 | Richard A. Henkler /s/ | Attorney |
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| Documents being submitted: | Files |
|---|--|
| us-fee-sheet | BUR920030174US1-usfees.xml us-fee-sheet.xsl us-fee-sheet.dtd |
| us-assignment | BUR920030174US1-usassn.xml us-assignment.xsl us-assignment.dtd BUR920030174US1Assignment1of2.tif BUR920030174US1Assignment2of2.tif |
| us-request | BUR920030174US1-usrequ.xml us-request.dtd us-request.xsl |
| us-declaration | BUR920030174US1Declaration1of1.tif |
| application-body | BUR920030174US1spec-trans.xml us-application-body.xsl application-body.dtd wipo.ent mathml2.dtd mathml2-qname-1.mod isoamsa.ent isoamsb.ent isoamsc.ent isoamsn.ent isoamso.ent isoamsr.ent isogr3.ent isomfrk.ent isomopf.ent isomscr.ent isotech.ent isobox.ent isocyr1.ent isocyr2.ent isodia.ent isolat1.ent isolat2.ent isonum.ent isopub.ent mmlextra.ent mmlalias.ent soextblx.dtd BUR920030174US1FIGSsheet1of3.tif BUR920030174US1FIGSsheet2of3.tif BUR920030174US1FIGSsheet3of3.tif |
| Comments | |
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